

FGP20N60UFD 600 V, 20 A Field Stop IGBT

Features

- High Current Capability
- Low Saturation Voltage: V_{CE(sat)} = 1.8 V @ I_C = 20 A
- High Input Impedance
- Fast Switching
- RoHS Compliant

Applications

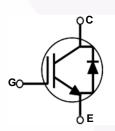
• Solar Inverter, UPS, Welder, PFC

March 2015

General Description

Using novel field stop IGBT technology, Fairchild's field stop IGBTs offer the optimum performance for solar inverter, UPS, welder and PFC applications where low conduction and switching losses are essential.





Absolute Maximum Ratings

Symbol	Description		Ratings	Unit
V _{CES}	Collector to Emitter Voltage		600	V
N/	Gate to Emitter Voltage		±20	V
V _{GES}	Transient Gate-to-Emitter Voltage	±30	V	
I _C	Collector Current	@ T _C = 25°C	40	A
	Collector Current	@ T _C = 100 ^o C	20	A
I _{CM (1)}	Pulsed Collector Current	@ T _C = 25°C	60	А
P _D	Maximum Power Dissipation	@ T _C = 25°C	165	W
	Maximum Power Dissipation	@ T _C = 100 ^o C	66	W
Т _Ј	Operating Junction Temperature		-55 to +150	°C
T _{stg}	Storage Temperature Range		-55 to +150	°C
Τ _L	Maximum Lead Temp. for soldering Purposes, 1/8" from case for 5 seconds	300	°C	

Notes:

1: Repetitive rating: Pulse width limited by max. junction temperature

Thermal Characteristics

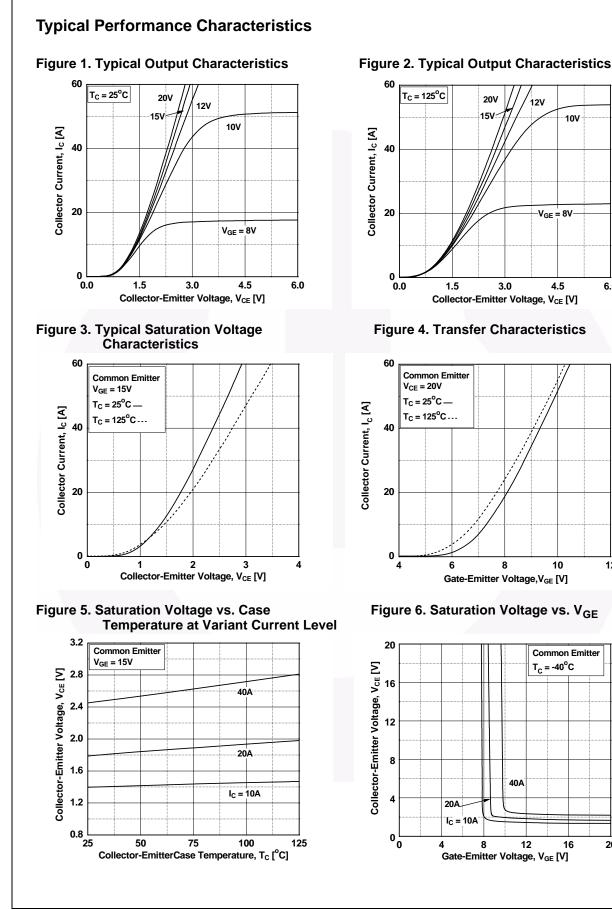
Symbol	Parameter	Тур.	Max.	Unit	
R _{0JC} (IGBT) Thermal Resistance, Junction to Case		-	0.76	°C/W	
$R_{\theta JC}$ (Diode)	Thermal Resistance, Junction to Case	-	2.51	°C/W	
R _{0JA} Thermal Resistance, Junction to Ambient		-	62.5	°C/W	

-		ackage Reel Size		Таре	Tape Width		ntity	
							50ea	
Electric	al Char	acteristics of the l	GBT T _{c = 2}	5°C unless otherwise noted				
Symbol			Test Conditions		Min.	Тур.	Max.	Unit
Off Charac	toristics							
BV _{CES}		to Emitter Breakdown Voltage	V _{GE} = 0V, I _C = 250µA		600	-	-	V
ΔBV _{CES} / ΔT _J	Temperature Coefficient of Breakdown Voltage		$V_{GE} = 0 \text{ V}, I_{C} = 250 \mu\text{A}$		-	0.6	-	V/ºC
CES Collector Cut-Off Current		Cut-Off Current	$V_{CE} = V_{CES}, V_{GE} = 0 V,$ $T_C = 25^{\circ}C$		-	-	250	μA
			$V_{CE} = V_{CES}$ $T_C = 125^{\circ}C$, V _{GE} = 0 V,	-	-	1	mA
I _{GES}	G-E Leak	age Current	$V_{GE} = V_{GES}$	$V_{CE} = 0V$	-	-	±400	nA
On Charac	teristics							
V _{GE(th)}	G-E Three	shold Voltage	I _C = 250 μA,	, V _{CE} = V _{GE}	4.0	5.0	6.5	V
			I _C = 20 A, V _C	_{GE} = 15 V	-	1.8	2.4	V
V _{CE(sat)} Collector to Emitter Saturation Voltage		$I_{\rm C} = 20 \text{ A}, V_{\rm C}$ $T_{\rm C} = 125^{\rm o}{\rm C}$	_{GE} = 15 V,	-	2.0	-	V	
Dynamic C	haracteris	tics						
C _{ies}	Input Cap	acitance			-	940	-	pF
C _{oes}	Output Ca	apacitance	[−] V _{CE} = 30 V _, V _{GE} = 0 V, f = 1 MHz	-	110	-	pF	
C _{res}	Reverse	Fransfer Capacitance			-	40	-	pF
Switching	Characteri	stics						
t _{d(on)}	Turn-On [Delay Time			-	13	-	ns
t _r	Rise Time	•			-	17	-	ns
t _{d(off)}	Turn-Off [Delay Time	V _{CC} = 400 V	′, I _C = 20 A,	-	87	-	ns
t _f	Fall Time		$R_{G} = 10 \Omega$, $V_{GE} = 15 V$,		-	32	64	ns
Eon	Turn-On S	Switching Loss	Inductive Lo	ad, T _C = 25°C	-	0.38	-	mJ
E _{off}	Turn-Off S	Switching Loss	+			0.26	-	mJ
E _{ts}	Total Swit	ching Loss			-	0.64	-	mJ
t _{d(on)}	Turn-On [Delay Time			-	13	-	ns
t _r	Rise Time)			-	16	-	ns
t _{d(off)}	Turn-Off	Delay Time	V _{CC} = 400 V	/, I _C = 20 A,	-	92	- /	ns
t _f	Fall Time		$R_{G} = 10 \Omega$, V	V _{GE} = 15 V,	-	63	-	ns
E _{on}	Turn-On S	Switching Loss	Inductive Load, T _C = 125°C		-	0.41	-	mJ
E _{off}	Turn-Off S	Switching Loss			-	0.36	-	mJ
E _{ts}	Total Swit	ching Loss			-	0.77	-	mJ
Qg	Total Gate	e Charge			-	63	-	nC
Q _{ge}	Gate to E	mitter Charge	V _{CE} = 400 V, I _C = 20 A, V _{GE} = 15 V		-	7	-	nC
Q _{gc}	Gate to C	ollector Charge			-	32	-	nC

Symbol	Parameter	Test Conditions		Min.	Тур.	Max	Unit
V_{FM}	Diode Forward Voltage	I _F = 10 A	$T_C = 25^{\circ}C$	-	1.9	2.5	V
			$T_{\rm C} = 125^{\rm o}{\rm C}$	-	1.7	-	
t _{rr}	Diode Reverse Recovery Time	I _F = 10 A, dI _F /dt = 200 A/μs	$T_{\rm C} = 25^{\rm o}{\rm C}$	-	35	-	ns
			$T_{\rm C} = 125^{\rm o}{\rm C}$	-	57	-	
Q _{rr}	Diode Reverse Recovery Charge		$T_C = 25^{\circ}C$	-	41	-	nC
			$T_{C} = 125^{\circ}C$	-	96	-	

6.0

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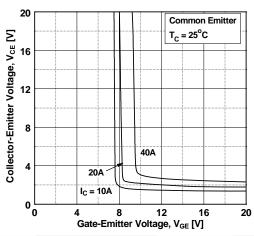
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Typical Performance Characteristics







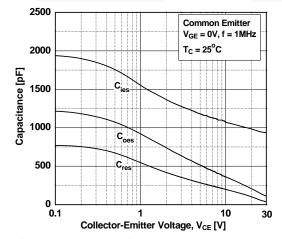


Figure 11. SOA Characteristics

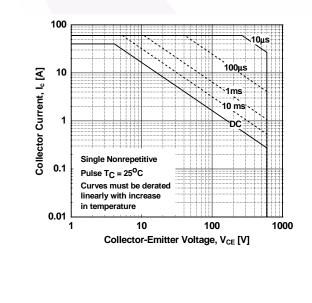


Figure 8. Saturation Voltage vs. V_{GE}

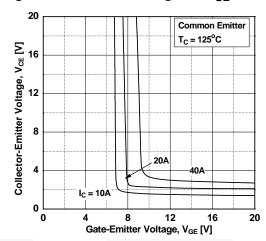


Figure 10. Gate charge Characteristics

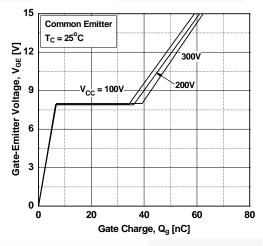
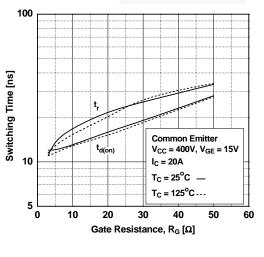
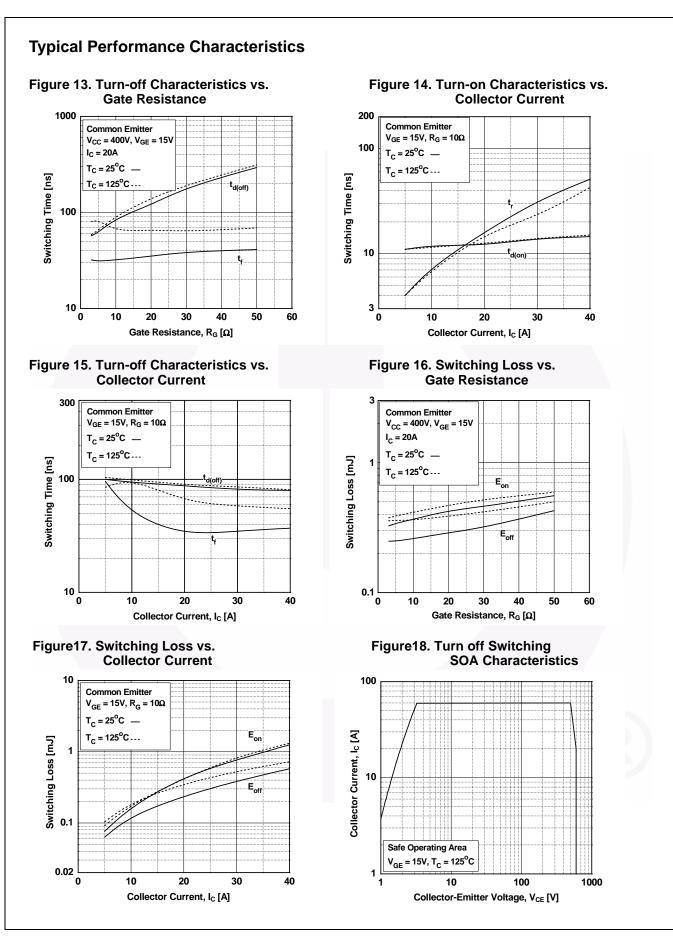
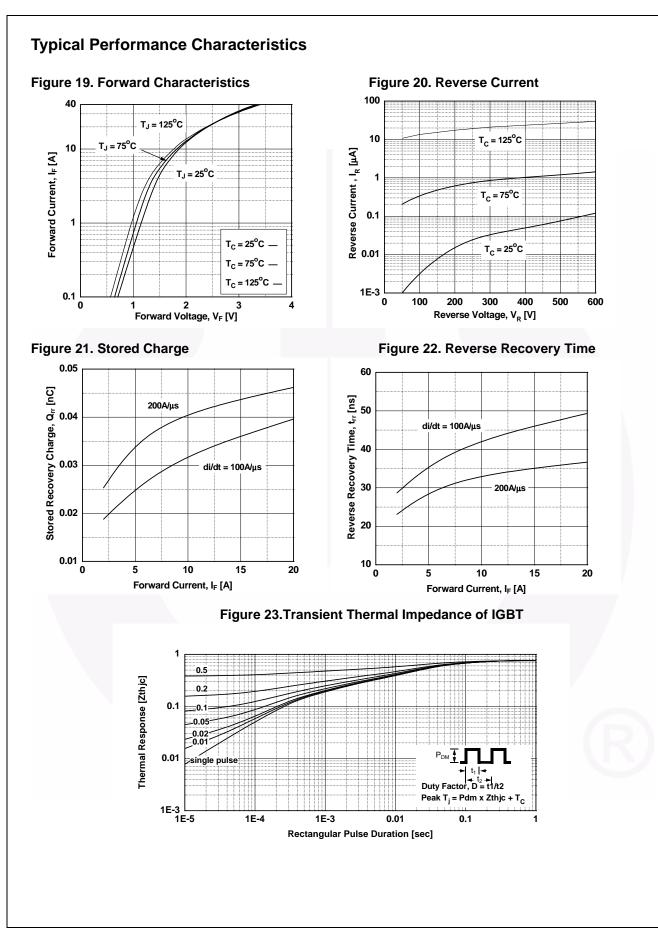


Figure 12. Turn-on Characteristics vs. Gate Resistance





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